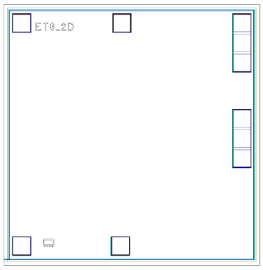
HIGH DIRECTIVITY

Monolithic Amplifier Die MNA-2A-D+

50Ω 0.5 to 4.5 GHz

THE BIG DEAL

- Choice of supply voltage, +2.8V to +5V
- Internal DC blocking at RF input and output
- High directivity, +21 dB typ.
- Output power, +17.5 dBm typ.



+RoHS Compliant
The +Suffix identifies RoHS Compliance.
See our website for methodologies and qualifications

SEE ORDERING INFORMATION ON THE LAST PAGE

APPLICATIONS

- Buffer amplifier
- Cellular infrastructure
- Communications satellite
- Defense

PRODUCT OVERVIEW

MNA-2A-D+ is a wideband PHEMT based MMIC amplifier die with high active Directivity. MNA integrates the entire matching network and majority of the bias circuit inside the die, reducing the need for complicated external circuits. This approach makes the MNA amplifier die extremely straightforward to use. This design operates on a single 2.8 to 5V supply, is well matched for 50Ω. MNA series models are available in Die and packaged form.

KEY FEATURES

Features	Advantages
Excellent Active Directivity (Isolation- Gain) 21-36 dB	Ideal for use as a buffer amplifier minimizing interaction of adjacent circuits
Integrates DC blocks and RF choke	Minimizes external components, component count and circuit area.
Single +2.8 to +5V operation	Amplifier can be used at low voltage such as +3V or standard +5V. +5V operation results in higher P1dB and OIP3.
Unpackaged die	Enables the user to integrate the amplifier directly into hybrids.

REV. B
ECO-015286
MNA-2A-D+
MCL NY
221005

Monolithic Amplifier Die MNA-2A-D+

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ELECTRICAL SPECIFICATIONS[1] AT 25°C

Parameter	Condition (GHz)	Vs=5V Min.	Vs=5V Typ.	Vs=5V Max.	Vs=2.8V Typ.	Units
Frequency Range		0.5		4.5	0.5-4.5	GHz
Gain	0.5		14.1		12.4	dB
	1.0		15.0		13.0	
	2.0		15.0		12.6	
	2.5		14.7		12.3	
	3.5		12.8		10.6	
	4.5		9.7		7.8	
Input Return Loss	0.5		8		8	dB
	1.0		16		17	
	2.0		19		22	
	2.5		17		19	
	3.5		14		14	
	4.5		9		9	
Output Return Loss	0.5		14		13	dB
	1.0		21		18	
	2.0		15		18	
	2.5		14		17	
	3.5		15		19	
	4.5		17		17	
Output Power at P1dB	0.5		19.2		10.3	dBm
	1.0		19.1		11.4	
	2.0		17.9		11.8	
	2.5		17.5		11.8	
	3.5		15.8		11.7	
	4.5		13.9		11.4	
Output IP3	0.5		32		22	dBm
	1.0		31		23	
	2.0		29		23	
	2.5		29		23	
	3.5		27		23	
	4.5		25		22	
Noise Figure	0.5		5.6		5.8	dB
	1.0		5.3		5.4	
	2.0		5.3		5.5	
	2.5		5.4		5.6	
	3.5		5.6		5.7	
	4.5		6.3		6.5	
Directivity (Isolation-Gain)	0.5		33		36	dB
	1.0		29		28	
	2.0		22		22	
	2.5		21		21	
	3.5		21		21	
	4.5		24		23	
DC Current			84	104	79	mA
Device Current Variation vs. Temperature[2]			32		15	µA/°C
Device Current Variation vs Voltage			0.0013		0.0034	mA/mV
Thermal resistance at 85°C (Junction to Lead)			54		54	°C/W

1. Measured on Mini-Circuits characterization test board. Die packaged in 3x3 mm MCLP package and soldered on test board TB-186+
2. (Current at 85°C -Current at -45°C)/130
3. (Current at 5.25V-Current at 3.9V)/1.35
4. (Current at 3.9V-Current at 2.66V)/1.24

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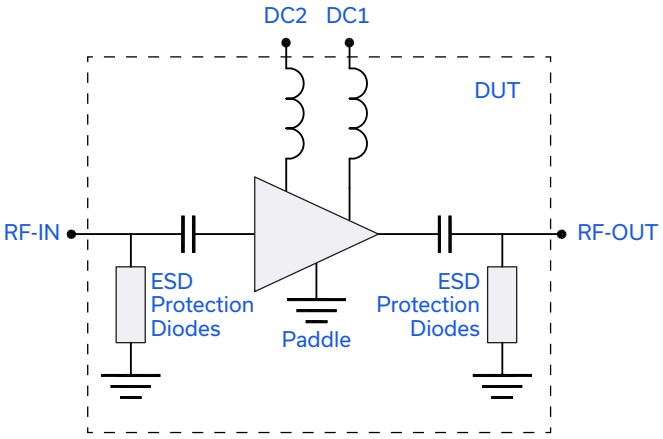
50Ω 0.5 to 4.5 GHz

MAXIMUM RATINGS[1,5]

Parameter	Ratings
Operating Temperature	-40°C to 85°C
DC Voltage	7V at DC1 (DC2 connected to DC1 via 33.2Ω) 1V at RF IN & RF OUT
Power Dissipation	800 mW
Input Power	+11 dBm at Vs=+2.8V and +16 dBm at+5V (continuous operation) +23 dBm (5 minutes max)

5. Permanent damage may occur if any of these limits are exceeded.
These ratings are not intended for continuous normal operation.

SIMPLIFIED SCHEMATIC AND PAD DESCRIPTION



Function	Description
RF IN	RF input pad.
RF-OUT	RF output pad
DC1 & DC2	DC Supply pad. Connect DC2 to DC1 via 33.2Ω resistor

1. Bond Pad material - Gold
2. Bottom of Die - Gold plated

CHARACTERIZATION CIRCUIT

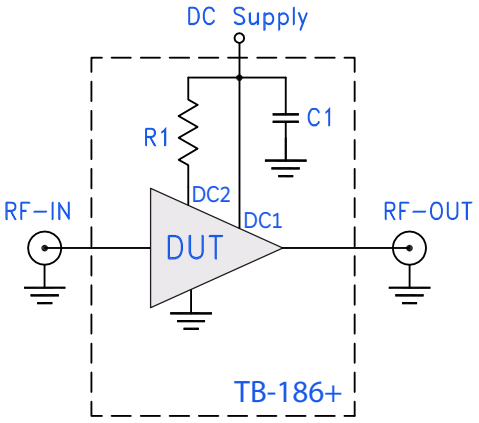


Fig 1. Block Diagram of Test Circuit used for characterization. (Die packaged in 3x3 mm MCLP package and soldered on Mini-Circuits Characterization test board TB-186+) Gain, Return loss, Output power at 1dB compression (P1 dB) , output IP3 (OIP3) and noise figure measured using Agilent's N5242A PNA-X microwave network analyzer.

Conditions:
1. Gain and Return loss: Pin= -25dBm
2. Output IP3 (OIP3): Two tones, spaced 1 MHz apart, 0 dBm/tone at output.

Component	Size	Value	Units
R1	0805	33.2	Ω
C1	0402	1000	ρ F

RECOMMENDED APPLICATION CIRCUIT

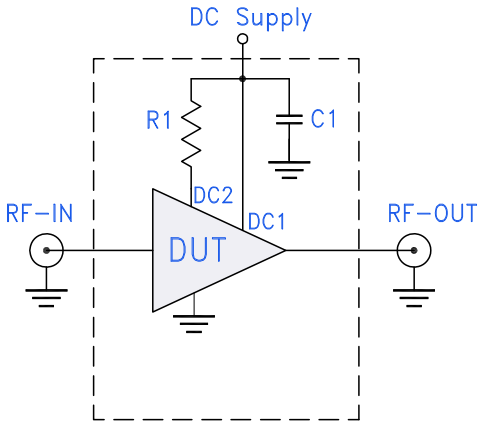


Fig 2. Test Board includes case, connectors, and components soldered to PCB

Component	Size	Value	Units
R1	0805	33.2	Ω
C1	0402	1000	ρ F

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DIE LAYOUT

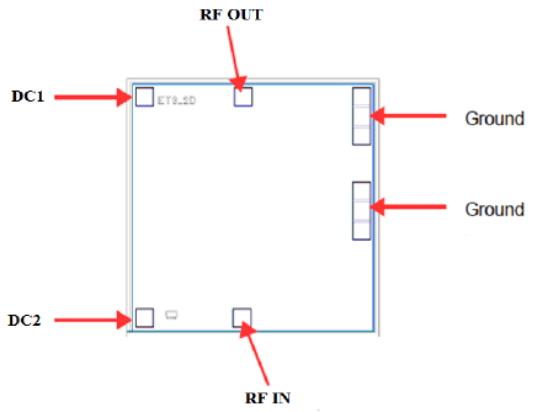


Fig 3. Die Layout

BONDING PAD POSITION

(Dimensions in µm, Typical)

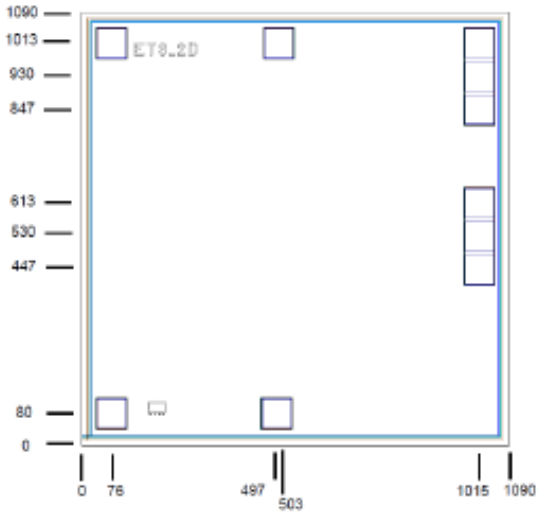
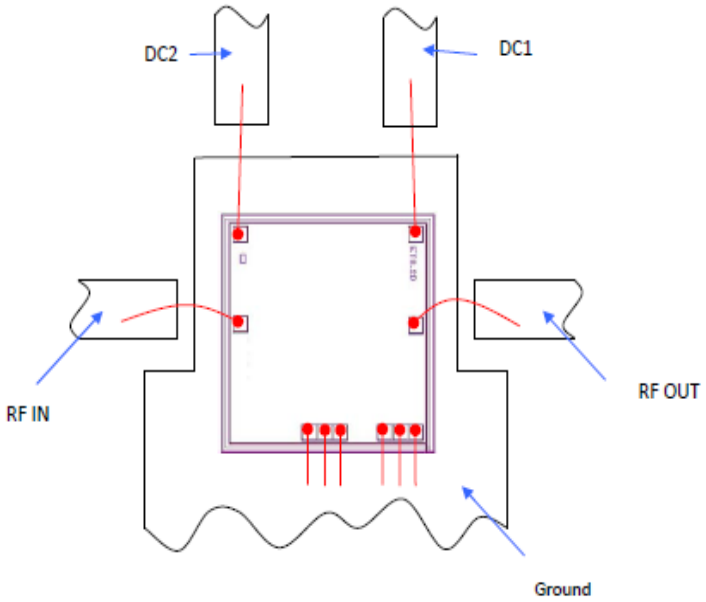


Fig 4. Bonding Pad Positions

CRITICAL DIMENSIONS

Parameter	Values
Die Thickness, µm	100
Die Width, µm	1090
Die Length, µm	1090
Bond Pad Size (RF In, RF Out, DC), µm	80 x 80
Bond Pad Size (Ground pad), µm	80 x 246

ASSEMBLY DIAGRAM



Note: Ground bond wires are optional.

RECOMMENDED WIRE LENGTH, TYPICAL

Wire	Wire Length (mm)	Wire Loop Height (mm)
RF In, RF Out	1.20	0.15
DC	0.60	0.15
Ground	0.35	0.15

ASSEMBLY PROCEDURE

1. Storage
   Die should be stored in a dry nitrogen purged desiccators or equivalent.
2. ESD
   MMIC PHEMT amplifier Die are susceptible to electrostatic and mechanical damage. Die are supplied in antistatic protected material, which should be open in clean room conditions at an appropriately grounded anti-static workstation.
3. Die Handling and Attachment
   Devices need careful handling using correctly designed collets, it is recommended to handle the chip along the edges with a custom design collet. The die mounting surface must be clean and flat. Using conductive silver filled epoxy, recommended epoxies are Ablestik 84-1 LMISR4 or equivalents. Apply sufficient epoxy to meet required epoxy bond line thickness, epoxy fillet height and epoxy coverage around total periphery. Parts shall be cured in a nitrogen filled atmosphere per manufacturer's cure condition. The surface of the chip has exposed air bridges and should not be touched with vacuum collet, tweezers or fingers.
4. Wire Bonding
   Bond pad openings in the surface passivation above the bond pads are provided to allow wire bonding to the Die gold bond pads. Thermo-sonic bonding is used with minimized ultrasonic content. Bond force, time, ultrasonic power and temperature are all critical parameters. Suggested wire is pure gold, 1mil diameter. Bonds must be made from the bond pads on the die to the packaged or substrate. All bond wire length and bond wire height should be kept as short as possible unless specified by the Assembly Drawing to minimize performance degradation due to undesirable series inductance.

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50Ω 0.5 to 4.5 GHz

ADDITIONAL DETAILED TECHNICAL INFORMATION IS AVAILABLE ON OUR DASH BOARD.

Performance Data	Data Table Swept Graphs S-Parameter (S2P Files) Data Set with and without port extension(.zip file)	
Case Style	Die	
Die Ordering and packaging information	Quantity, Package Small, Gel - Pak: 5,10,50,100 KGD* Medium†, Partial wafer: KGD*<1295 Large†, Full Wafer †Available upon request contact sales representative Refer to AN-60-067	Model No. MNA-2A-DG+ MNA-2A-DP+ MNA-2A-DF+
Environmental Ratings	ENV-80	

*Known Good Die ('KGD') means that the die in question have been subjected to Mini-Circuits DC test performance criteria and measurement instructions and that the parametric data of such die fall within a predefined range. While DC testing is not definitive, it does provide a higher degree of confidence that die are capable of meeting typical RF electrical performance specified by Mini-Circuits.

ESD RATING**

Human Body Model (HBM): Class 1A (250 to < 500V) in accordance with ANSI/ESD STM 5.1 - 2001

**Tested in _x_ xxL MCLP Package

NOTES

A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.

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Typical Performance Data

NOTE: Use PDF Bookmarks to view DATA at required conditions

Definitions:
Input Return Loss = -S11 (dB)
Gain(Power Gain) = S21 (dB)
Reverse Isolation = -S12 (dB)
Output Return Loss = -S22 (dB)

TEST CONDITIONS: Vd = 3.9V, Id = 84.29 mA @ Temperature = +25degC

FREQ	Gain	Isolation	Input Return Loss	Output Return Loss	Stability		IP-3 Output	1dB Comp. Output	Noise Figure
(MHz)	(dB)	(dB)	(dB)	(dB)	K	Measure	(dBm)	(dBm)	(dB)
200	5.33	45.80	1.06	2.71	4.75	0.84	21.82	10.32	8.59
300	11.15	43.00	3.26	6.42	7.67	1.15	26.88	15.65	6.87
400	13.09	45.69	5.85	10.44	14.24	1.15	28.25	17.36	6.47
500	13.83	48.10	8.26	14.37	21.13	1.11	28.85	17.84	6.48
600	14.19	49.15	10.40	18.18	25.02	1.08	28.80	18.07	6.17
700	14.42	47.93	12.34	22.70	22.17	1.05	28.98	18.19	6.09
800	14.53	46.27	14.15	26.60	18.53	1.04	29.06	18.11	5.93
900	14.63	44.68	15.86	32.71	15.50	1.02	29.13	18.35	5.90
1000	14.69	42.95	17.54	35.13	12.73	1.02	28.80	18.18	5.86
1100	14.73	42.19	19.17	32.35	11.68	1.01	29.12	18.28	5.81
1200	14.75	41.19	20.74	28.92	10.41	1.01	29.15	18.21	5.78
1300	14.77	40.29	22.00	26.42	9.38	1.00	28.95	18.25	5.75
1400	14.78	39.36	22.83	24.32	8.42	1.00	28.87	18.18	5.69
1500	14.77	38.90	23.27	22.78	7.99	1.00	28.84	18.09	5.64
1600	14.78	38.31	23.05	21.54	7.44	0.99	28.71	18.11	5.68
1700	14.75	37.60	22.23	20.66	6.87	0.99	28.71	18.15	5.58
1800	14.70	37.03	21.42	19.92	6.46	0.99	28.51	18.08	5.61
1900	14.67	36.55	20.66	19.27	6.12	0.99	28.51	18.19	5.55
2000	14.60	36.26	19.70	18.68	5.93	0.99	28.58	18.10	5.53
2100	14.55	36.03	19.07	18.29	5.80	0.99	28.41	17.99	5.51
2200	14.50	35.65	18.43	17.53	5.56	0.99	28.43	17.97	5.49
2300	14.40	35.17	17.78	17.56	5.31	0.99	28.28	17.87	5.49
2400	14.31	35.08	17.33	17.48	5.30	0.99	28.15	17.95	5.45
2500	14.21	34.73	16.86	17.29	5.13	1.00	28.04	17.88	5.47
2600	14.09	35.08	16.68	17.63	5.42	1.00	28.09	17.76	5.47
2700	13.94	34.19	15.96	17.80	4.97	1.00	27.93	17.73	5.46
2800	13.83	34.44	15.99	17.93	5.18	1.00	27.75	17.61	5.48
2900	13.64	33.99	15.43	18.48	5.03	1.01	27.59	17.42	5.48
3000	13.53	33.43	15.05	18.39	4.77	1.01	27.67	17.25	5.43
3100	13.34	33.47	14.84	19.07	4.90	1.01	27.60	17.25	5.50
3200	13.07	34.06	14.30	20.55	5.39	1.02	27.08	17.15	5.51
3300	12.97	32.89	14.12	20.25	4.77	1.02	26.78	16.85	5.55
3400	12.77	32.96	13.91	21.34	4.92	1.02	26.87	16.88	5.57
3500	12.53	32.92	13.40	22.91	5.02	1.03	26.77	16.67	5.60
3600	12.28	33.17	13.21	23.73	5.31	1.03	26.48	16.60	5.62
3700	11.98	32.51	13.21	25.64	5.10	1.03	26.26	16.28	5.73
3800	11.78	33.08	12.32	27.45	5.51	1.05	26.14	16.27	5.76
3900	11.53	32.58	12.06	27.82	5.33	1.05	25.95	16.21	5.80
4000	11.19	33.45	11.34	30.06	6.05	1.07	25.89	15.80	5.85
4100	10.91	33.28	10.79	27.83	6.06	1.08	25.75	15.74	5.95
4200	10.62	33.01	10.25	25.62	5.99	1.08	25.50	15.43	5.99
4300	10.25	32.19	9.69	22.63	5.59	1.09	25.45	15.24	6.13
4400	10.09	33.37	9.28	22.49	6.44	1.11	25.19	15.10	6.19
4500	9.82	32.25	9.06	19.91	5.78	1.11	25.01	14.87	6.25
4600	9.48	32.65	8.44	19.11	6.14	1.12	24.86	14.79	6.38
4700	9.15	31.89	8.23	17.54	5.78	1.12	24.55	14.54	6.49
4800	8.86	31.95	7.93	16.72	5.93	1.13	24.52	14.32	6.55
4900	8.45	31.34	7.18	16.17	5.58	1.15	24.16	14.11	6.74
5000	8.22	33.02	7.14	15.78	6.92	1.15	24.07	13.82	6.78
5100	7.82	32.70	6.96	15.17	6.89	1.15	23.80	13.55	6.89
5200	7.35	31.84	6.71	14.68	6.48	1.16	23.50	13.34	7.05
5300	6.66	31.66	6.48	14.56	6.76	1.17	23.06	12.91	7.32
5400	6.18	32.61	6.06	15.55	7.77	1.20	22.79	12.23	7.44
5500	5.60	31.93	5.96	15.56	7.62	1.21	22.27	12.14	7.70

Typical Performance Data

Definitions:
Input Return Loss = -S11 (dB)
Gain(Power Gain) = S21 (dB)
Reverse Isolation = -S12 (dB)
Output Return Loss = -S22 (dB)

TEST CONDITIONS: Vd = 2.8V, Id =80.69 mA @ Temperature = +25degC

FREQ	Gain	Isolation	Input Return Loss	Output Return Loss	Stability		IP-3 Output	1dB Comp. Output	Noise Figure
(MHz)	(dB)	(dB)	(dB)	(dB)	K	Measure	(dBm)	(dBm)	(dB)
200	4.69	45.98	1.16	2.82	5.90	0.85	13.72	4.67	8.80
300	10.25	44.33	3.39	6.55	10.38	1.15	19.88	9.22	7.04
400	12.03	47.50	6.02	10.20	20.01	1.13	22.28	11.13	6.60
500	12.67	48.98	8.45	13.18	26.62	1.09	23.22	11.86	6.55
600	12.97	49.14	10.61	15.29	28.46	1.06	23.44	12.30	6.23
700	13.15	46.66	12.59	16.80	21.88	1.03	23.81	12.50	6.20
800	13.23	44.77	14.44	17.47	17.86	1.02	23.92	12.57	5.98
900	13.30	43.20	16.22	18.00	15.02	1.01	24.16	12.90	6.03
1000	13.34	41.92	18.03	18.07	13.02	1.00	23.99	12.85	5.92
1100	13.36	40.61	19.90	18.14	11.24	0.99	24.32	12.93	5.89
1200	13.36	39.88	21.83	18.17	10.37	0.99	24.34	12.87	5.87
1300	13.36	38.96	23.75	18.13	9.35	0.99	24.28	12.98	5.81
1400	13.35	38.33	25.44	17.96	8.73	0.98	24.20	12.98	5.78
1500	13.33	37.83	26.77	17.92	8.26	0.98	24.26	12.97	5.72
1600	13.32	37.08	26.97	17.67	7.58	0.98	24.19	12.99	5.75
1700	13.28	36.53	26.05	17.64	7.15	0.98	24.25	13.08	5.67
1800	13.22	36.16	24.96	17.65	6.89	0.98	24.19	13.04	5.65
1900	13.18	35.65	23.83	17.70	6.54	0.98	24.27	13.23	5.61
2000	13.11	35.35	22.55	17.80	6.36	0.98	24.30	13.09	5.61
2100	13.04	34.80	21.61	17.86	6.01	0.99	24.22	13.15	5.54
2200	12.98	34.79	20.75	17.73	6.03	0.99	24.15	13.07	5.59
2300	12.88	34.06	19.90	18.21	5.61	0.99	24.15	13.14	5.56
2400	12.79	33.92	19.33	18.55	5.58	0.99	24.16	13.25	5.55
2500	12.69	33.79	18.65	18.67	5.56	0.99	24.14	13.28	5.55
2600	12.56	33.94	18.31	19.28	5.73	1.00	24.18	13.28	5.54
2700	12.42	33.04	17.42	20.27	5.26	1.00	24.08	13.23	5.57
2800	12.30	33.32	17.23	20.41	5.50	1.00	24.01	13.22	5.60
2900	12.11	32.92	16.53	22.02	5.37	1.01	23.85	13.15	5.55
3000	11.99	32.26	16.00	22.47	5.04	1.01	23.94	13.24	5.55
3100	11.81	32.35	15.57	23.20	5.19	1.02	23.89	13.25	5.61
3200	11.55	32.64	14.84	24.50	5.49	1.02	23.44	13.26	5.57
3300	11.44	31.79	14.56	24.92	5.04	1.02	23.26	12.99	5.65
3400	11.24	31.88	14.18	25.91	5.21	1.03	23.42	13.06	5.70
3500	11.00	31.71	13.59	25.81	5.21	1.03	23.37	13.08	5.70
3600	10.75	32.11	13.26	26.08	5.59	1.04	23.14	13.19	5.79
3700	10.46	31.35	13.08	22.81	5.27	1.04	23.05	12.89	5.83
3800	10.26	31.92	12.22	23.75	5.69	1.05	22.96	13.02	5.90
3900	10.02	31.51	11.90	21.96	5.54	1.05	22.87	12.99	5.95
4000	9.69	32.18	11.17	21.55	6.12	1.07	22.94	12.72	6.01
4100	9.42	31.89	10.61	20.12	6.03	1.07	22.82	12.69	6.04
4200	9.15	31.52	10.08	18.90	5.87	1.08	22.68	12.56	6.13
4300	8.80	30.86	9.56	17.26	5.56	1.09	22.69	12.49	6.24
4400	8.63	31.84	9.14	17.19	6.26	1.10	22.51	12.43	6.32
4500	8.38	30.93	8.91	16.00	5.73	1.10	22.41	12.38	6.41
4600	8.06	31.18	8.34	15.34	5.97	1.11	22.27	12.18	6.53
4700	7.74	30.61	8.13	14.48	5.72	1.11	21.99	12.20	6.66
4800	7.48	30.62	7.84	14.03	5.83	1.11	22.00	12.03	6.70
4900	7.08	30.17	7.16	13.47	5.59	1.13	21.69	11.83	6.87
5000	6.88	31.54	7.10	13.43	6.66	1.13	21.65	11.69	6.93
5100	6.50	31.24	6.93	13.10	6.64	1.13	21.42	11.55	7.10
5200	6.08	30.55	6.70	12.83	6.34	1.14	21.17	11.30	7.22
5300	5.45	30.57	6.51	12.74	6.75	1.15	20.73	10.95	7.44
5400	5.00	31.44	6.09	13.59	7.70	1.18	20.53	10.34	7.56
5500	4.42	30.60	6.01	13.88	7.44	1.19	19.90	10.37	7.85

Typical Performance Data

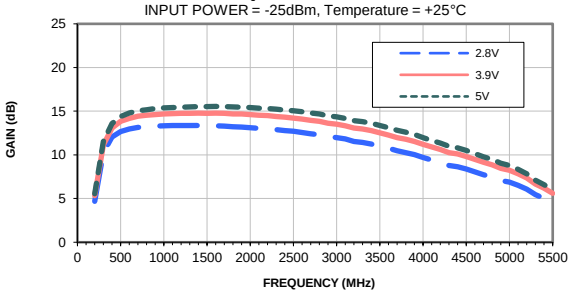
Definitions:
Input Return Loss = -S11 (dB)
Gain(Power Gain) = S21 (dB)
Reverse Isolation = -S12 (dB)
Output Return Loss = -S22 (dB)

TEST CONDITIONS: Vd = 5V, Id = 85.62 mA @ Temperature = +25degC

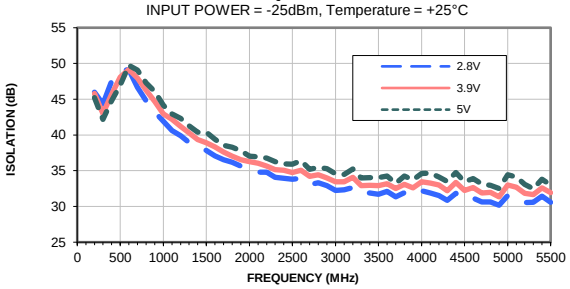
FREQ	Gain	Isolation	Input Return Loss	Output Return Loss	Stability		IP-3 Output	1dB Comp. Output	Noise Figure
(MHz)	(dB)	(dB)	(dB)	(dB)	K	Measure	(dBm)	(dBm)	(dB)
200	5.55	45.24	1.02	2.63	4.07	0.83	23.85	11.68	8.48
300	11.53	42.16	3.21	6.26	6.46	1.15	29.96	17.81	6.77
400	13.58	44.78	5.78	10.29	11.96	1.15	31.52	20.04	6.41
500	14.38	46.98	8.16	14.22	17.31	1.11	32.10	20.48	6.40
600	14.79	49.74	10.28	17.83	24.91	1.08	32.06	20.64	6.10
700	15.04	49.08	12.22	21.46	23.50	1.05	32.40	20.69	6.04
800	15.17	47.29	14.02	23.20	19.31	1.03	32.20	20.61	5.89
900	15.29	46.05	15.69	23.54	16.74	1.02	32.16	20.65	5.89
1000	15.37	44.15	17.28	23.32	13.45	1.01	31.97	20.46	5.81
1100	15.42	42.94	18.83	22.34	11.68	1.00	31.91	20.50	5.75
1200	15.47	42.30	20.16	21.21	10.82	1.00	31.98	20.44	5.73
1300	15.50	41.30	21.18	20.16	9.62	0.99	31.88	20.39	5.69
1400	15.52	40.37	21.66	19.24	8.60	0.99	31.62	20.18	5.63
1500	15.53	40.38	21.83	18.29	8.58	0.99	31.53	20.13	5.60
1600	15.55	39.39	21.57	17.59	7.62	0.99	31.43	20.12	5.64
1700	15.52	38.53	20.75	16.96	6.90	0.98	31.09	19.86	5.52
1800	15.49	38.29	20.02	16.37	6.70	0.98	31.04	19.77	5.55
1900	15.46	37.79	19.36	15.81	6.32	0.98	30.76	19.74	5.47
2000	15.41	37.03	18.50	15.29	5.80	0.98	30.81	19.59	5.44
2100	15.36	36.93	17.95	14.96	5.73	0.98	30.59	19.49	5.42
2200	15.32	36.77	17.39	14.33	5.61	0.98	30.68	19.49	5.43
2300	15.22	36.28	16.85	14.24	5.34	0.98	30.39	19.23	5.42
2400	15.14	35.97	16.50	14.08	5.20	0.98	30.26	19.35	5.43
2500	15.05	35.93	16.15	13.94	5.21	0.98	29.93	19.07	5.40
2600	14.93	36.41	16.02	14.11	5.58	0.98	29.85	18.99	5.40
2700	14.79	35.20	15.42	14.07	4.93	0.98	29.86	18.99	5.40
2800	14.68	35.47	15.56	14.17	5.16	0.98	29.65	18.81	5.44
2900	14.48	35.27	15.10	14.37	5.15	0.99	29.42	18.63	5.40
3000	14.37	34.57	14.81	14.26	4.81	0.98	29.37	18.42	5.38
3100	14.18	34.49	14.72	14.74	4.89	0.99	29.31	18.38	5.45
3200	13.90	35.24	14.25	15.63	5.51	1.00	28.84	18.22	5.41
3300	13.82	33.97	14.10	15.37	4.82	1.00	28.50	17.98	5.46
3400	13.61	34.01	13.96	15.98	4.97	1.00	28.66	17.90	5.49
3500	13.36	34.01	13.43	16.88	5.11	1.01	28.33	17.72	5.50
3600	13.10	34.25	13.32	17.39	5.41	1.02	28.10	17.61	5.55
3700	12.80	33.21	13.31	19.02	5.01	1.02	28.00	17.31	5.63
3800	12.58	34.24	12.39	19.41	5.71	1.03	27.89	17.28	5.71
3900	12.33	33.70	12.08	20.35	5.51	1.04	27.56	17.17	5.74
4000	11.97	34.62	11.38	21.76	6.31	1.06	27.63	16.74	5.81
4100	11.66	34.68	10.77	22.64	6.51	1.07	27.40	16.64	5.86
4200	11.35	34.14	10.21	23.35	6.26	1.08	27.11	16.32	5.93
4300	10.97	33.51	9.59	23.68	6.00	1.10	27.10	16.13	6.03
4400	10.80	34.73	9.17	23.44	6.93	1.11	26.65	15.93	6.09
4500	10.50	33.43	8.93	21.17	6.12	1.11	26.58	15.79	6.19
4600	10.14	33.91	8.29	21.11	6.58	1.13	26.49	15.56	6.29
4700	9.78	33.14	8.05	19.28	6.20	1.13	26.20	15.37	6.41
4800	9.48	32.97	7.75	18.28	6.21	1.14	26.05	15.13	6.46
4900	9.04	32.51	6.97	18.18	5.95	1.17	25.67	14.93	6.64
5000	8.77	34.43	6.95	17.13	7.60	1.17	25.45	14.65	6.73
5100	8.35	34.14	6.76	16.37	7.61	1.17	25.21	14.36	6.79
5200	7.83	33.08	6.48	15.79	7.00	1.18	24.92	14.14	6.96
5300	7.10	32.47	6.24	15.70	6.99	1.19	24.39	13.74	7.21
5400	6.58	33.81	5.85	16.51	8.41	1.22	23.97	13.09	7.35
5500	5.99	32.98	5.75	15.78	8.08	1.23	23.78	12.99	7.62

Typical Performance Curves

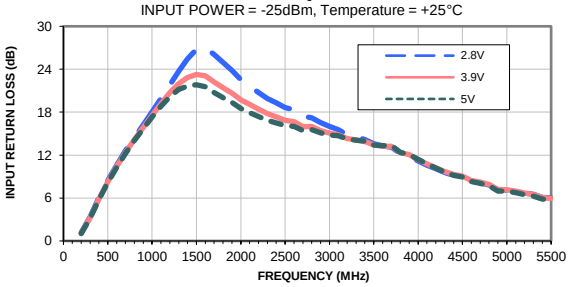
GAIN vs. FREQUENCY & DEVICE VOLTAGE
INPUT POWER = -25dBm, Temperature = +25°C



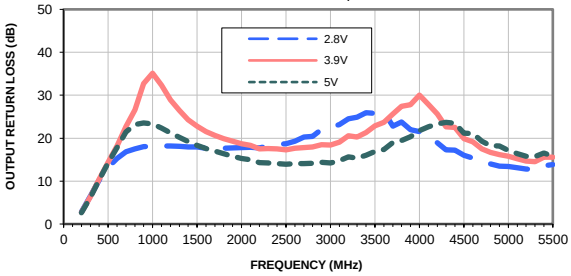
ISOLATION vs. FREQUENCY & DEVICE VOLTAGE
INPUT POWER = -25dBm, Temperature = +25°C



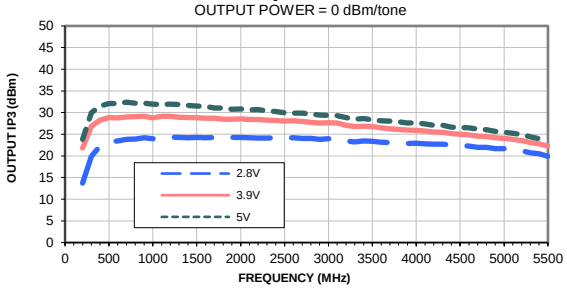
INPUT RETURN LOSS vs. FREQUENCY & DEVICE VOLTAGE
INPUT POWER = -25dBm, Temperature = +25°C



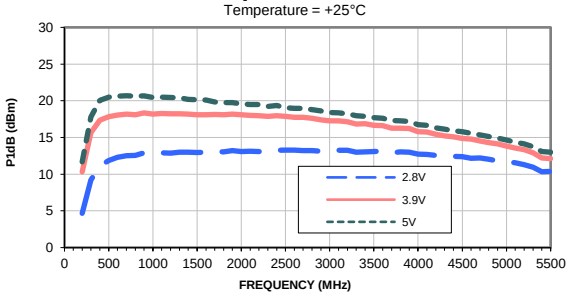
OUTPUT RETURN LOSS vs. FREQUENCY & DEVICE VOLTAGE
INPUT POWER = -25dBm, Temperature = +25°C



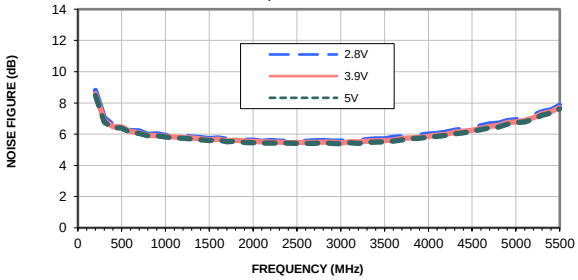
OUTPUT IP3 vs. FREQUENCY & DEVICE VOLTAGE
OUTPUT POWER = 0 dBm/tone



P1dB vs. FREQUENCY & DEVICE VOLTAGE
Temperature = +25°C



NOISE FIGURE vs. FREQUENCY & DEVICE VOLTAGE
Temperature = +25°C



Mini-Circuits

Environmental Specifications ENV80

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85° C or -40° to 105° C or -55° to 105° C or -45° to 105° C Ambient Environment	Refer to Individual Model Data Sheet
Storage Environment (Die)	-65° to 150°C	Individual Model Data Sheet
Storage Environment(Packaging)	-40° to 70°C and 40 to 60% humidity (In Factory Shipped Package)	

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